Cascadable Silicon Bipolar MMIC Amplifiers

Technical Data

Features

- Cascadable 50 Ω Gain Block
- 3 dB Bandwidth: DC to 2.7 GHz
- 12.0 dB Typical Gain at 1.0 GHz
- 10.0 dBm Typical P_{1 dB} at 1.0 GHz
- Unconditionally Stable (k>1)
- Cost Effective Ceramic Microstrip Package

Description

The MSA-0335 is a high performance silicon bipolar Monolithic Microwave Integrated Circuit (MMIC) housed in a cost effective, microstrip package. This MMIC is designed for use as a general purpose 50 Ω gain block. Typical applications include narrow and broad band IF and RF amplifiers in industrial and military applications.

The MSA-series is fabricated using HP's 10 GHz f_T, 25 GHz f_{MAX}, silicon bipolar MMIC process which uses nitride self-alignment, ion implantation, and gold metallization to achieve excellent performance, uniformity and reliability. The use of an external bias resistor for temperature and current stability also allows bias flexibility.

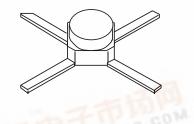
Available in cut lead version (package 36) as MSA-0336.

MSA-0335, -0336

24小时加急出货

HEWLETT

35 micro-X Package^[1]

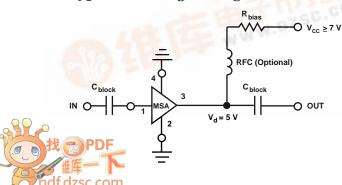


Note:

专业PCB打样工

1. Short leaded 36 package available upon request.

Typical Biasing Configuration



MSA-0335, -0336 Absolute Maximum Ratings

| Parameter | Absolute Maximum ^[1] | | | | |
|------------------------------------|---------------------------------|--|--|--|--|
| Device Current | 80 mA | | | | |
| Power Dissipation ^[2,3] | 425 mW | | | | |
| RF Input Power | +13dBm | | | | |
| Junction Temperature | 200°C | | | | |
| Storage Temperature ^[4] | -65 to 200°C | | | | |

| Thermal Resistance ^[2,5] : | |
|----------------------------------------------|--|
| $\theta_{\rm jc} = 150^{\circ} {\rm C/W}$ | |

Notes:

- 1. Permanent damage may occur if any of these limits are exceeded.
- 2. $T_{CASE} = 25^{\circ}C.$
- 3. Derate at 6.7 mW/°C for $T_C > 136$ °C.
- 4. Storage above $+150^{\circ}$ C may tarnish the leads of this package making it difficult to solder into a circuit.
- 5. The small spot size of this technique results in a higher, though more accurate determination of θ_{jc} than do alternate methods. See MEASURE-MENTS section "Thermal Resistance" for more information.

| Symbol | Parameters and Test Conditions: | Units | Min. | Тур. | Max. | |
|-------------------|----------------------------------------|-----------------------|-------|------|-------|-------|
| GP | Power Gain $(S_{21} ^2)$ | f = 0.1 GHz | dB | 11.5 | 12.5 | 13.5 |
| ΔG_P | Gain Flatness | f = 0.1 to 1.6 GHz | dB | | ± 0.6 | ± 1.0 |
| $f_{3 dB}$ | 3 dB Bandwidth | | GHz | | 2.7 | |
| VSWR | Input VSWR | f = 0.1 to 3.0 GHz | | | 1.6:1 | |
| VSWR | Output VSWR $f = 0.1$ to | | | | 1.7:1 | |
| NF | 50Ω Noise Figure | f = 1.0 GHz | dB | | 10.0 | |
| P _{1 dB} | Output Power at 1 dB Gain Compression | f = 1.0 GHz | dBm | | 6.0 | |
| IP ₃ | Third Order Intercept Point | f = 1.0 GHz | dBm | | 23.0 | |
| tD | Group Delay | f = 1.0 GHz | psec | | 125 | |
| Vd | Device Voltage | | V | 4.5 | 5.0 | 5.5 |
| dV/dT | Device Voltage Temperature Coefficient | | mV/°C | | -8.0 | |

Electrical Specifications^[1], $T_A = 25^{\circ}C$

Notes:

1. The recommended operating current range for this device is 20 to 50 mA. Typical performance as a function of current is on the following page.

| MSA-0335, -03 | 336 Part Number | Ordering Information |
|---------------|-----------------|-----------------------------|
|---------------|-----------------|-----------------------------|

| Part Number | No. of Devices | Container | | |
|--------------|----------------|----------------|--|--|
| MSA-0335 | 10 | Strip | | |
| MSA-0336-BLK | 100 | Antistatic Bag | | |
| MSA-0336-TR1 | 1000 | 7" Reel | | |

For more information, see "Tape and Reel Packaging for Semiconductor Devices."

| Freq. S ₁₁ | | 1 | S ₂₁ | | | S ₁₂ | | | \mathbf{S}_{22} | |
|-----------------------|-----|------|-----------------|------|-----|-----------------|------|-----|-------------------|------|
| GHz | Mag | Ang | dB | Mag | Ang | dB | Mag | Ang | Mag | Ang |
| 0.1 | .05 | 177 | 12.6 | 4.25 | 175 | -18.6 | .118 | 1 | .17 | -8 |
| 0.2 | .05 | 170 | 12.5 | 4.24 | 170 | -18.3 | .121 | 2 | .17 | -17 |
| 0.4 | .04 | 161 | 12.5 | 4.20 | 160 | -18.3 | .122 | 3 | .17 | -33 |
| 0.6 | .04 | 156 | 12.4 | 4.15 | 151 | -18.3 | .121 | 5 | .18 | -47 |
| 0.8 | .03 | 149 | 12.2 | 4.09 | 142 | -17.9 | .128 | 8 | .19 | -61 |
| 1.0 | .02 | 154 | 12.1 | 4.02 | 132 | -17.6 | .131 | 9 | .20 | -73 |
| 1.5 | .03 | -104 | 11.6 | 3.79 | 109 | -16.8 | .145 | 13 | .20 | -102 |
| 2.0 | .08 | -136 | 10.9 | 3.49 | 87 | -15.7 | .164 | 11 | .21 | -133 |
| 2.5 | .14 | -157 | 10.0 | 3.16 | 71 | -14.9 | .180 | 13 | .23 | -155 |
| 3.0 | .21 | -176 | 9.0 | 2.81 | 53 | -14.6 | .187 | 8 | .24 | -173 |
| 3.5 | .27 | 170 | 7.9 | 2.49 | 36 | -13.9 | .202 | 4 | .25 | 178 |
| 4.0 | .31 | 157 | 6.9 | 2.20 | 20 | -13.6 | .209 | -1 | .24 | 177 |
| 5.0 | .37 | 125 | 4.9 | 1.76 | -10 | -12.9 | .226 | -12 | .20 | 165 |
| 6.0 | .51 | 87 | 2.8 | 1.38 | -38 | -12.8 | .230 | -25 | .22 | 130 |

MSA-0335, -0336 Typical Scattering Parameters (Z $_0$ = 50 Ω , T $_A$ = 25°C, I $_d$ = 35 mA)

A model for this device is available in the DEVICE MODELS section.

Typical Performance, $T_A = 25^{\circ}C$

(unless otherwise noted)

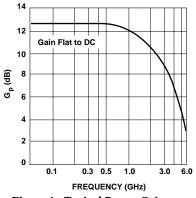


Figure 1. Typical Power Gain vs. Frequency, T_A = 25°C, I_d = 35 mA.

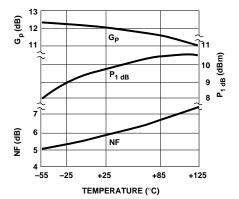


Figure 4. Output Power at 1 dB Gain Compression, NF and Power Gain vs. Mounting Surface Temperature, f=1.0 GHz. L₁ = 35 mA.

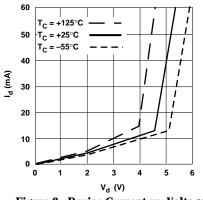
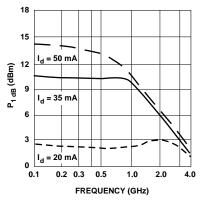
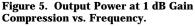
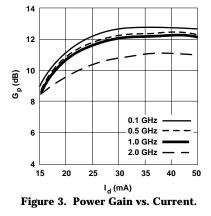


Figure 2. Device Current vs. Voltage.







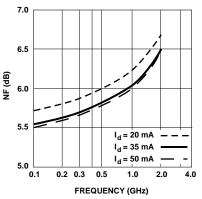
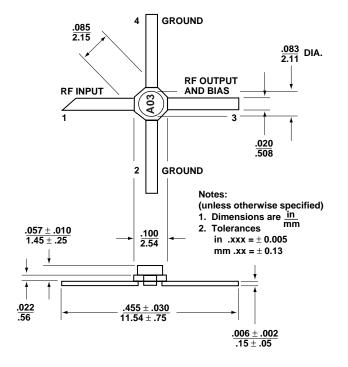


Figure 6. Noise Figure vs. Frequency.



35 micro-X Package Dimensions